

Description

The PI4IOE5V96248 provides general purpose remote I/O expansion for most microcontroller families via the two-line bidirectional bus (I²C-bus) and is a part of the Fast-mode Plus family.

The PI4IOE5V96248 supports high I²C-bus drive (25mA) so that many more devices can be on the bus without the need for bus buffers, high total package sink capacity (1200mA) that supports having all 25mA LEDs on at the same time and more device addresses (64) are available to allow many more devices on the bus without address conflicts.

The device consists of a 48-bit quasi-bidirectional port and an I²C-bus interface. The PI4IOE5V96248 has a low current consumption and includes latched outputs with high current drive capability for directly driving LEDs.

It also possesses an interrupt line ($\overline{\text{INT}}$) which can be connected to the interrupt logic of the microcontroller. By sending an interrupt signal on this line, the remote I/O can inform the microcontroller if there is incoming data on its ports without having to communicate via the I²C-bus. The internal Power-On Reset (POR) or software reset sequence initializes the I/Os as inputs.

Features

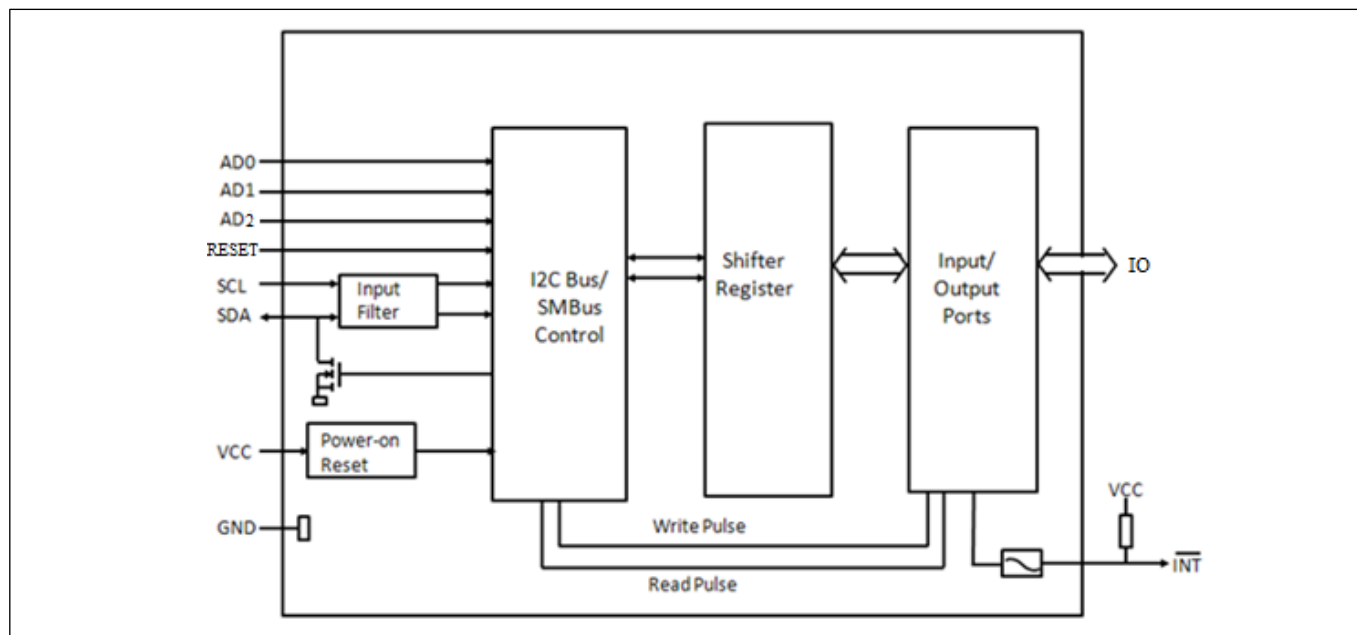
- Operation power supply voltage from 2.3V to 5.5V
- 48-bit remote I/O pins that default to inputs at power-up
- 1MHz I²C-bus interface
- Compliant with the I²C-bus Fast and Standard modes
- 5.0V tolerant I/Os
- SDA with 30 mA sink capability for 4000pF buses
- Latched outputs with 25mA sink capability for directly driving LEDs
- Total package sink capability of 1200mA
- Active LOW open-drain interrupt output
- Low standby current
- 64 programmable slave addresses using 3 address pins
- ESD protection (4KV HBM and 1KV CDM)
- Latch-up tested (exceeds 100mA)
- Packaging (Pb-free and Green):
 - 56-Pin, 7mm x 7mm, TQFN (ZL)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](#) or your local Diodes representative.

<https://www.diodes.com/quality/product-definitions/>

Notes:

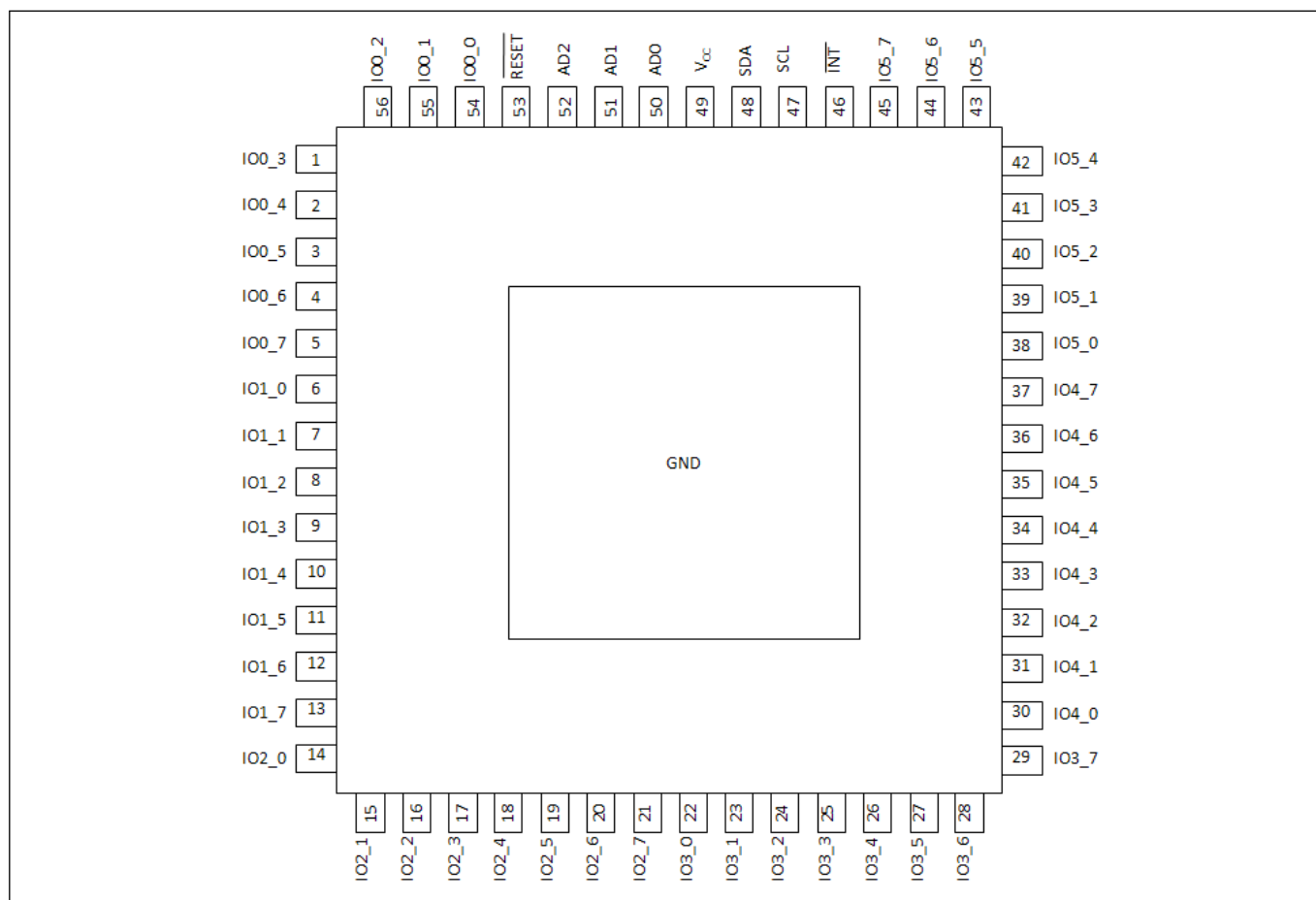
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Block Diagram



Note: All I/Os are set to inputs at reset.

Pin Configuration



Pin Description

Pin Number	Name	Type	Description
54-56, 1 - 5	IO0_0 - IO0_7	I/O	Port 0 input/output 0 - 7
6 - 13	IO1_0 - IO1_7	I/O	Port 1 input/output 0 - 7
14 - 21	IO2_0 - IO2_7	I/O	Port 2 input/output 0 - 7
22 - 29	IO3_0 - IO3_7	I/O	Port 3 input/output 0 - 7
30 - 37	IO4_0 - IO4_7	I/O	Port 4 input/output 0 - 7
38 - 45	IO5_0 - IO5_7	I/O	Port 5 input/output 0 - 7
46	INT	O	Interrupt output (open-drain)
47	SCL	I	Serial clock line input
48	SDA	I	Serial data line open-drain
49	V _{CC}	P	Supply voltage
50	AD0	I	Address input 0
51	AD1	I	Address input 1
52	AD2	I	Address input 2
53	RESET	I	RESET
Thermal Pad	GND	G	Ground

* I = Input; O = Output; P = Power; G = Ground

Maximum Ratings

Power Supply.....	-0.5V to +6.0V
Voltage on an I/O Pin.....	GND-0.5V to +6.0V
Input Current.....	±20mA
Output Current on an I/O Pin.....	±50mA
Supply Current.....	±160mA
Ground Supply Current.....	1500mA
Total Power Dissipation.....	600mW
Operation Temperature.....	-40~85°C
Storage Temperature.....	-65~150°C
Maximum Junction Temperature, Tj (max).....	125°C

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Static Characteristics

V_{CC} = 2.3V to 5.5V; GND = 0; T_{amb} = -40°C to +85°C; unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Power Supply						
V _{CC}	Supply voltage		2.3		5.5	V
I _{CC}	Supply current	Operating mode; V _{CC} = 5.5V; no load; f _{SCL} = 1MHz		250	500	μA
I _{sb}	Standby current	Standby mode; V _{CC} = 5.5V; no load; V _I = V _{CC} ; f _{SCL} = 0; I/O = inputs		0.25	1	uA
V _{POR}	Power-on reset voltage ⁽¹⁾			1.16	1.41	V
Input SCL, Input/Output SDA						
V _{IL}	Low level input voltage		-0.5		+0.3V _{CC}	V
V _{IH}	High level input voltage		0.7V _{CC}		5.5	V
I _{OL}	Low level output current	V _{OL} = 0.4V	20			mA
I _L	Leakage current	V _I = V _{CC} = GND	-1		1	μA
C _i	Input capacitance	V _I = GND		5	10	pF
I/Os						
I _{OL}	Low level output current	V _{CC} = 2.3V; V _{OL} = 0.5V ⁽²⁾	12	28		mA
		V _{CC} = 3.0V; V _{OL} = 0.5V ⁽²⁾	17	35		mA
		V _{CC} = 4.5V; V _{OL} = 0.5V ⁽²⁾	25	42		mA
I _{OL(tot)}	Total LOW-level output current	V _{OL} = 0.5V; V _{CC} = 4.5V			600	mA
I _{OH}	HIGH-level output current	VOH = GND	-30	-359	-480	uA
I _{trt(pu)}	Transient boosted pull-up current	VOH = GND	-0.5	-1.0		mA
C _i	Off-state Input capacitance	⁽³⁾		9	10	pF
C _o	Off-state Output capacitance	⁽³⁾		9	10	pF
Interrupt INT						
I _{OL}	Low level output current	V _{OL} = 0.4V	6			mA
C _o	Output capacitance			2.1	10	pF
Select Inputs AD2, AD1, AD0 and RESET						
V _{IL}	Low level input voltage		-0.5		+0.81	V
V _{IH}	High level input voltage	V _{CC} = 3.3V	+1.8		5.5	V
I _L	Input leakage current		-1		1	μA

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
C _i	Input capacitance			2.4	10	pF

Note:

- VCC must be lowered to 0.2 V for at least 20us in order to reset part.
- Each I/O must be externally limited to a maximum of 25 mA and the total package limited to 1200 mA due to internal busing limits.
- The value is not tested, but verified on sampling basis.

Dynamic Characteristics

Symbol	Parameter	Standard Mode I ² C		Fast Mode I ² C		Fast Mode Plus I ² C		Unit
		Min	Max	Min	Max	Min	Max	
f _{SCL}	SCL clock frequency	0	100	0	400	0	1000	kHz
t _{BUF}	bus free time between a STOP and START condition	4.7		1.3		0.5		μs
t _{HD;STA}	hold time (repeated) START condition	4.0		0.6		0.26		μs
t _{SU;STA}	set-up time for a repeated START condition	4.7		0.6		0.26		μs
t _{SU;STO}	set-up time for STOP condition	4.0		0.6		0.26		μs
t _{VD;ACK} ⁽¹⁾	data valid acknowledge time		3.45		0.9		0.45	μs
t _{HD;DAT} ⁽²⁾	data hold time	0		0		0		ns
t _{VD;DAT}	data valid time		3.45		0.9		0.45	ns
t _{SU;DAT}	data set-up time	250		100		50		ns
t _{LOW}	LOW period of the SCL clock	4.7		1.3		0.5		μs
t _{HIGH}	HIGH period of the SCL clock	4.0		0.6		0.26		μs
t _f	fall time of both SDA and SCL signals		300		300		120	ns
t _r	rise time of both SDA and SCL signals		1000		300		120	ns
t _{SP}	pulse width of spikes that must be suppressed by the input filter		50		50		50	ns
Port Timing C_L ≤ 100pF								
t _{V(Q)}	Data output valid time ⁽³⁾		200		200		200	ns
t _{SU(D)}	Data input set-up time	0		0		0		ns
t _{H(D)}	Data input hold time	4		4		4		μs
Interrupt Timing C_L ≤ 100pF								
t _{V(D)}	Valid time on pin $\overline{\text{INT}}$		4		4		4	μs
t _{d(rst)}	Reset time on pin $\overline{\text{INT}}$		4		4		4	μs
Reset Timing								
t _{w(rst)}	Reset pulse width		25		25		25	ns
t _{vrec(rst)}	Reset recovery time ⁽⁴⁾		0		0		0	ns
t _{rst}	Reset time		1		1		1	μs

Note:

- t_{VD;ACK} = time for acknowledgement signal from SCL LOW to SDA (out) LOW.
- t_{VD;DAT} = minimum time for SDA data out to be valid following SCL LOW.
- t_{V(Q)} measured from 0.7VCC on SCL to 50% I/O output.

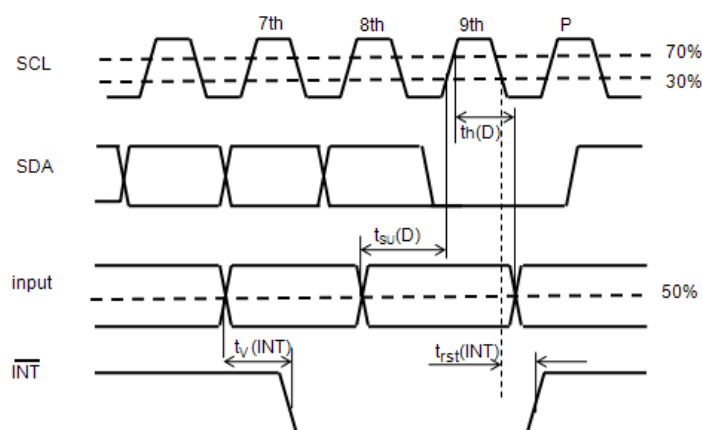


Figure 1. Timing Parameters for INT Signal

Details Description

a. Device Address

Following a START condition, the bus master must send the address of the slave it is accessing and the operation it wants to perform (read or write). The address of the PI4IOE5V96248 is shown in below. Slave address pins AD2, AD1, and AD0 choose 1 of 64 slave addresses. To conserve power, no internal pull-up resistors are incorporated on AD2, AD1, and AD0. Address values depending on AD2, AD1, and AD0 can be found in Table 2 “PI4IOE5V96248 address map”.

Table 1. PI4IOE5V96248 Address

	b7(MSB)	b6	b5	b4	b3	b2	b1	b0
Address Byte	A6	A5	A4	A3	A2	A1	A0	R/W

The last bit of the first byte defines the operation to be performed. When set to logic 1 a read is selected, while a logic 0 selects a write operation.

Table 2. PI4IOE5V96248 Address Maps

AD2	AD1	AD0	A6	A5	A4	A3	A2	A1	A0	Address (Write)	Address (Read)
GND	SCL	GND	0	0	1	0	0	0	0	20h	21h
GND	SCL	VDD	0	0	1	0	0	0	1	22h	23h
GND	SDA	GND	0	0	1	0	0	1	0	24h	25h
GND	SDA	VDD	0	0	1	0	0	1	1	26h	27h
VDD	SCL	GND	0	0	1	0	1	0	0	28h	29h
VDD	SCL	VDD	0	0	1	0	1	0	1	2Ah	2Bh
VDD	SDA	GND	0	0	1	0	1	1	0	2Ch	2Dh
VDD	SDA	VDD	0	0	1	0	1	1	1	2Eh	2Fh
GND	SCL	SCL	0	0	1	1	0	0	0	30h	31h
GND	SCL	SDA	0	0	1	1	0	0	1	32h	33h
GND	SDA	SCL	0	0	1	1	0	1	0	34h	35h
GND	SDA	SDA	0	0	1	1	0	1	1	36h	37h
VDD	SCL	SCL	0	0	1	1	1	0	0	38h	39h
VDD	SCL	SDA	0	0	1	1	1	0	1	3Ah	3Bh
VDD	SDA	SCL	0	0	1	1	1	1	0	3Ch	3Dh
VDD	SDA	SDA	0	0	1	1	1	1	1	3Eh	3Fh
GND	GND	GND	0	1	0	0	0	0	0	40h	41h
GND	GND	VDD	0	1	0	0	0	0	1	42h	43h
GND	VDD	GND	0	1	0	0	0	1	0	44h	45h
GND	VDD	VDD	0	1	0	0	0	1	1	46h	47h
VDD	GND	GND	0	1	0	0	1	0	0	48h	49h
VDD	GND	VDD	0	1	0	0	1	0	1	4Ah	4Bh
VDD	VDD	GND	0	1	0	0	1	1	0	4Ch	4Dh
VDD	VDD	VDD	0	1	0	0	1	1	1	4Eh	4Fh
GND	GND	SCL	0	1	0	1	0	0	0	50h	51h
GND	GND	SDA	0	1	0	1	0	0	1	52h	53h
GND	VDD	SCL	0	1	0	1	0	1	0	54h	55h
GND	VDD	SDA	0	1	0	1	0	1	1	56h	57h
VDD	GND	SCL	0	1	0	1	1	0	0	58h	59h
VDD	GND	SDA	0	1	0	1	1	0	1	5Ah	5Bh
VDD	VDD	SCL	0	1	0	1	1	1	0	5Ch	5Dh

AD2	AD1	AD0	A6	A5	A4	A3	A2	A1	A0	Address (Write)	Address (Read)
VDD	VDD	SDA	0	1	0	1	1	1	1	5Eh	5Fh
SCL	SCL	GND	1	0	1	0	0	0	0	A0h	A1h
SCL	SCL	VDD	1	0	1	0	0	0	1	A2h	A3h
SCL	SDA	GND	1	0	1	0	0	1	0	A4h	A5h
SCL	SDA	VDD	1	0	1	0	0	1	1	A6h	A7h
SDA	SCL	GND	1	0	1	0	1	0	0	A8h	A9h
SDA	SCL	VDD	1	0	1	0	1	0	1	AAh	ABh
SDA	SDA	GND	1	0	1	0	1	1	0	ACH	ADh
SDA	SDA	VDD	1	0	1	0	1	1	1	A Eh	AFh
SCL	SCL	SCL	1	0	1	1	0	0	0	B0h	B1h
SCL	SCL	SDA	1	0	1	1	0	0	1	B2h	B3h
SCL	SDA	SCL	1	0	1	1	0	1	0	B4h	B5h
SCL	SDA	SDA	1	0	1	1	0	1	1	B6h	B7h
SDA	SCL	SCL	1	0	1	1	1	0	0	B8h	B9h
SDA	SCL	SDA	1	0	1	1	1	0	1	BAh	BBh
SDA	SDA	SCL	1	0	1	1	1	1	0	BCh	BDh
SDA	SDA	SDA	1	0	1	1	1	1	1	BEh	BFh
SCL	GND	GND	1	1	0	0	0	0	0	C0h	C1h
SCL	GND	VDD	1	1	0	0	0	0	1	C2h	C3h
SCL	VDD	GND	1	1	0	0	0	1	0	C4h	C5h
SCL	VDD	VDD	1	1	0	0	0	1	1	C6h	C7h
SDA	GND	GND	1	1	0	0	1	0	0	C8h	C9h
SDA	GND	VDD	1	1	0	0	1	0	1	CAh	CBh
SDA	VDD	GND	1	1	0	0	1	1	0	CCh	CDh
SDA	VDD	VDD	1	1	0	0	1	1	1	CEh	CFh
SCL	GND	SCL	1	1	1	0	0	0	0	E0h	E1h
SCL	GND	SDA	1	1	1	0	0	0	1	E2h	E3h
SCL	VDD	SCL	1	1	1	0	0	1	0	E4h	E5h
SCL	VDD	SDA	1	1	1	0	0	1	1	E6h	E7h
SDA	GND	SCL	1	1	1	0	1	0	0	E8h	E9h
SDA	GND	SDA	1	1	1	0	1	0	1	EAh	EBh
SDA	VDD	SCL	1	1	1	0	1	1	0	ECh	Edh
SDA	VDD	SDA	1	1	1	0	1	1	1	EEh	EFh

Quasi-bidirectional I/O Architecture

The PI4IOE5V96248's 48 ports (see Figure 2) are entirely independent and can be used either as input or output ports. Input data is transferred from the ports to the microcontroller in the Read mode. Output data is transmitted to the ports in the Write mode.

Every data transmission from the PI4IOE5V96248 must consist of a multiple of six bytes, the first byte will be referred to as IO_7 to IO_0, and the second byte as IO_15 to IO_8. The third will be referred to as IO_23 to IO_16, and so on.

This quasi-bidirectional I/O can be used as an input or output without the use of a control signal for data directions. At power-on the I/Os are HIGH. In this mode only a current source (I_{OH}) to VCC is active. An additional strong pull-up to VCC ($I_{trt}(pu)$) allows fast rising edges into heavily loaded outputs. These devices turn on when an output is written HIGH, and are switched off by the negative edge of SCL. The I/Os should be HIGH before being used as inputs. After power-on, as all the I/Os are set HIGH, all of them can be used as inputs. Any change in setting of the I/Os as either inputs or outputs can be done with the write mode.

Remark: If a HIGH is applied to an I/O which has been written earlier to LOW, a large current (I_{OL}) will flow to GND.

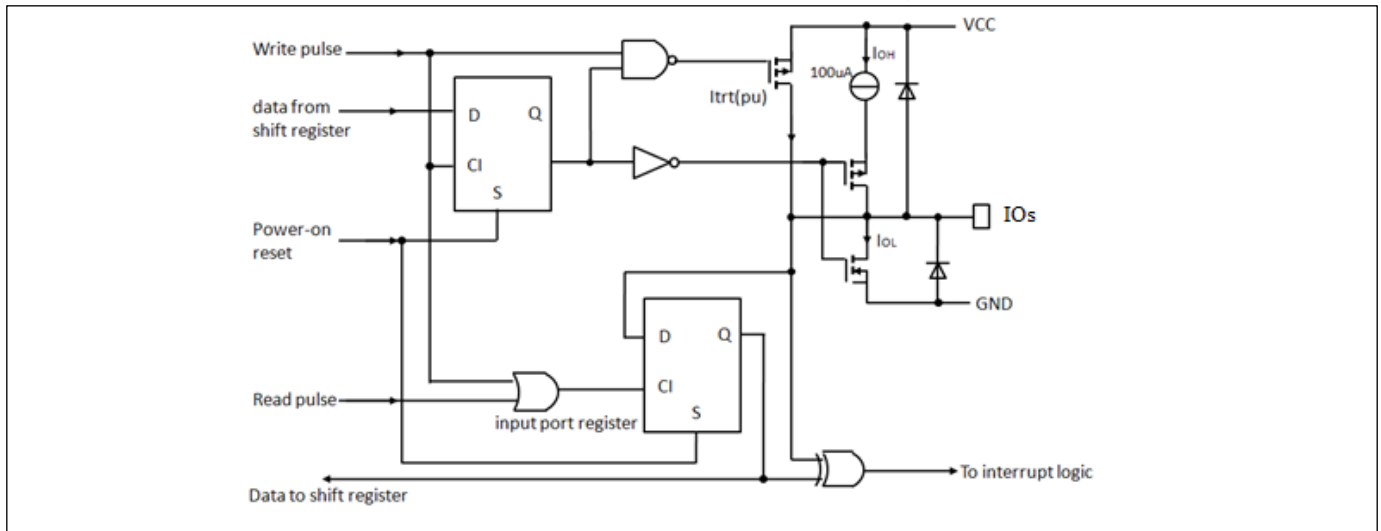


Figure 2. Simplified schematic diagram of IOX_0 to IOX_7

Writing to the Port (Output Mode)

To write, the master (microcontroller) first addresses the slave device. By setting the last bit of the byte containing the slave address to logic 0 the Write mode is entered. The PI4IOE5V96248 acknowledges and the master sends the first data byte for IO0_7 to IO0_0. After the first data byte is acknowledged by the PI4IOE5V96248, the second data byte IO1_7 to IO1_0 is sent by the master. After the second data byte is acknowledged by the PI4IOE5V96248, the third data byte IO2_7 to IO2_0 is sent by the master and so on. Once again, the PI4IOE5V96248 acknowledges the receipt of the data. Each 8-bit data is presented on the port lines after it has been acknowledged by the PI4IOE5V96248.

The number of data bytes that can be sent successively is not limited. After every six bytes, the previous data is overwritten.

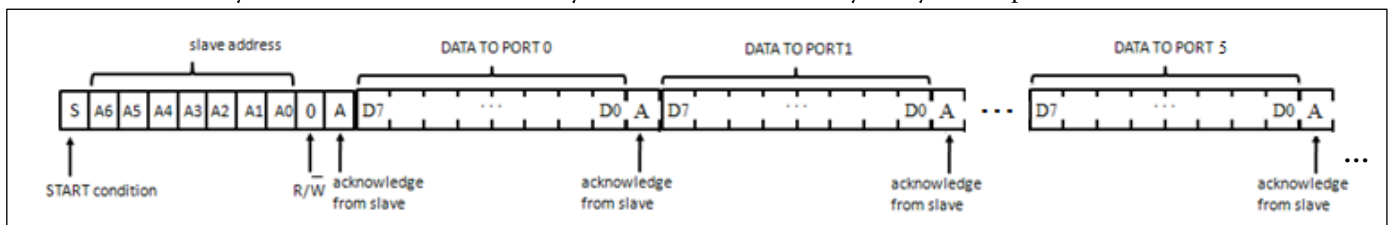


Figure 3. Write Mode

Reading from a Port (Input Mode)

All ports programmed as input should be set to logic 1. To read, the master (microcontroller) first addresses the slave device after it receives the interrupt. By setting the last bit of the byte containing the slave address to logic 1 the Read mode is entered.

The data bytes that follow on the SDA are the values on the ports.

If the data on the input port changes faster than the master can read, this data may be lost. Transfer of data can be stopped at any moment by a STOP condition. When this occurs, data present at the latest acknowledge phase is valid.

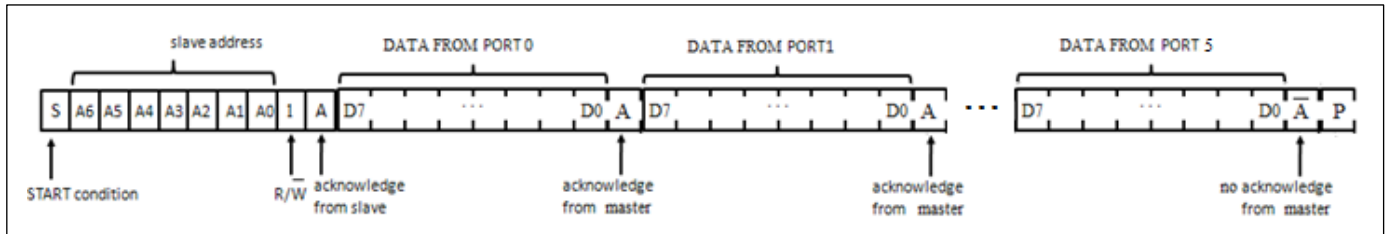


Figure 4. Read Input Port Register

Power-on Reset

When power is applied to VCC, an internal Power-On Reset (POR) holds the PI4IOE5V96248 in a reset condition until VCC has reached VPOR. At that point, the reset condition is released and the PI4IOE5V96248 registers and I²C-bus state machine will initialize to their default states. Thereafter VCC must be lowered below 0.2 V to reset the device.

Interrupt Output ($\overline{\text{INT}}$)

The PI4IOE5V96248 provides an open-drain interrupt ($\overline{\text{INT}}$) which can be fed to a corresponding input of the microcontroller.

This gives these chips a kind of master function which can initiate an action elsewhere in the system.

An interrupt is generated by any rising or falling edge of the port inputs. After time $t_{(V)D}$ the signal $\overline{\text{INT}}$ is valid.

The interrupt disappears when data on the port is changed to the original setting or data is read from or written to the device which has generated the interrupt.

In the write mode, the interrupt may become deactivated (HIGH) on the rising edge of the write to port pulse. On the falling edge of the write to port pulse the interrupt is definitely deactivated (HIGH).

The interrupt is reset in the read mode on the rising edge of the read from port pulse.

During the resetting of the interrupt itself, any changes on the I/Os may not generate an interrupt. After the interrupt is reset any change in I/Os will be detected and transmitted as an $\overline{\text{INT}}$.

RESET Input

A reset can be accomplished by holding the $\overline{\text{RESET}}$ pin LOW for a minimum of $t_{w(rst)}$. The PI4IOE5V96248 registers and I²C-bus state machine will be held in their default state until the $\overline{\text{RESET}}$ input is once again HIGH.

Part Marking

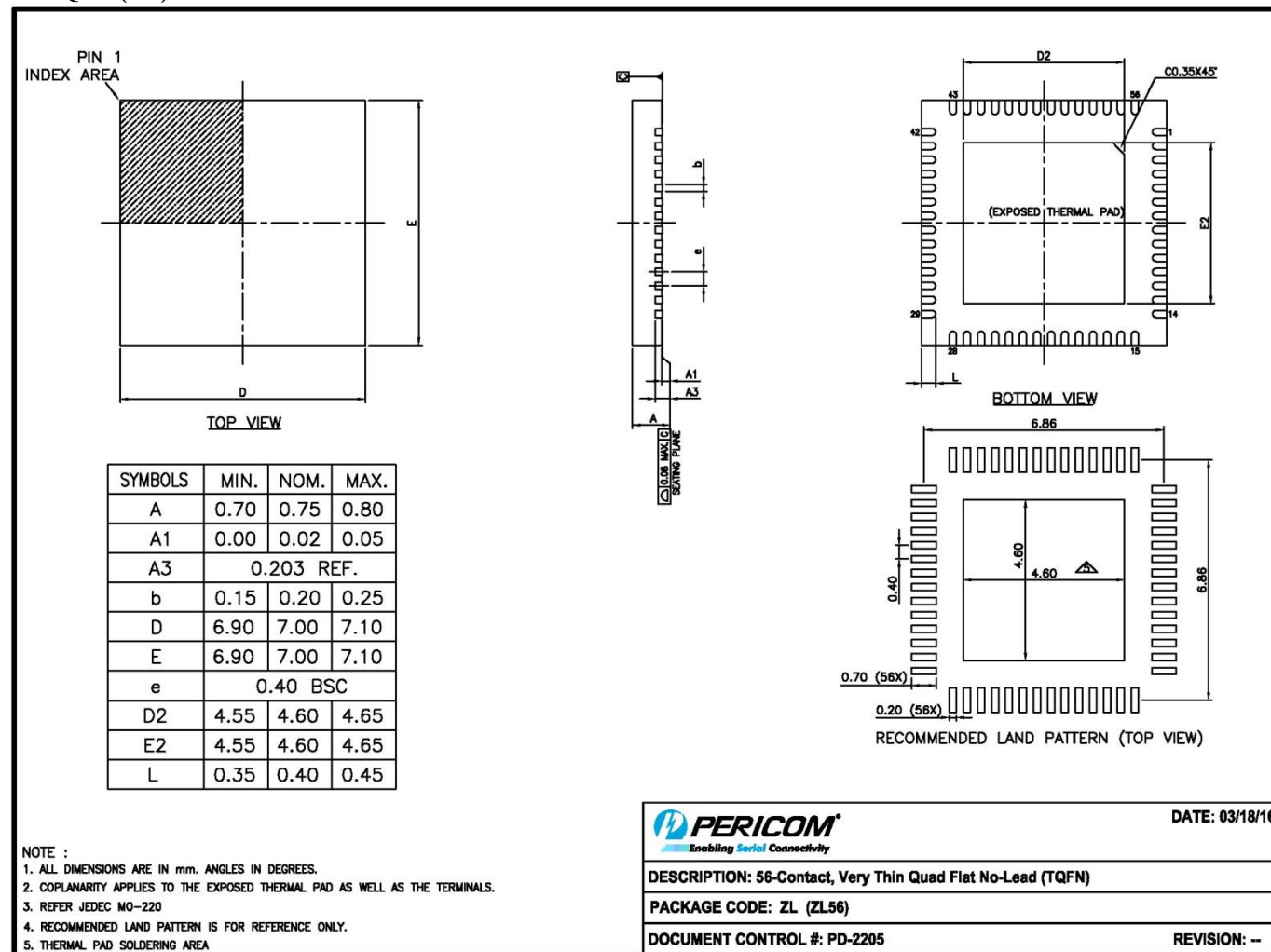
PI4IOE5V
96248ZLE
YYWWXX



YY: Year
WW: Workweek
1st X: Assembly Code
2nd X: Fab Code

Packaging Mechanical

56-TQFN (ZL)



For latest package info.

please check: <http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/>

Mechanical Data

- Surface Mount Package
- Moisture Sensitivity: Level 1 per J-STD-020
- Case Material: Molded Plastic, UL Flammability Rating 94V-0
- Terminals: Finish - Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 ③
- Weight: 0.125 grams (Approximate)

Ordering Information

Orderable Part Number	Package Code	Package Description
PI4IOE5V96248ZLEX	ZL	56-Contact, Very Thin Quad Flat No-Lead (TOFN)

Notes:

- No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- E = Pb-free and Green
- X suffix = Tape/Reel

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